SPECIFICATION

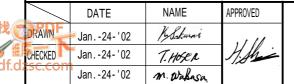
Device Name : SILICON DIODE

Type Name : YG963S6R

Spec.No. : MS5D1437

This material and the information herein is the property of Fuji Electric Co.,Ltd. They shall be neither reproduced, copied, lent, or disclosed in any way whatsoever for the use of any third party no used for the manufacturing purposes without the express written consent of Fuji Electric Co.,Ltd.

Fuji Electric Co.,Ltd. Matsumoto Factory



Fu ji Electric Co.,Ltd.

MS5D1437 1/12

DING.NO.

Revised Records

| Date | Classi- fication | Ind. | Content | Applied date | Drawn | Checked | Checked | Approved |
|-------|---------------------|------|-----------------|--------------|-------------|----------|-----------|----------|
| MAY22 | enactment | | | Issued | | K. | | T. |
| -2001 | | | | date | | SAKURAI | | HOSEN |
| JAN24 | alteration | а | ·add test items | Issued | 70 24 | | | 1111 |
| -2002 | | | | date | Py Sakura i | T. HOSER | M. Wakasa | H.Sh. |
| | | | | | | | | |
| | | | | | | | | |
| | | | | | | | | |
| | | | | | | | | |
| | | | | | | | | |
| | | | | | | | | |
| | | | | | | | | |
| | | | | | | | | |
| | | | | | | | | |
| | | | | | | | | |
| | | | | | | | | |
| | | | | | | | | |
| | | | | | | | | |
| | | | | | | | | |
| | | | | | | | | |

This material and the information herein is the property of Fuji Electric Co.,Ltd. They shall be neither reproduced, copied, lent, or disclosed in any way whatsoever for the use of any tint of party nor used for the manufacturing purposes without the express written consent of Fuji Electric Co.,Ltd.

Fuji Electric Co.,Ltd.

This specification provides the ratings and the test requirement for FUJI SILICON DIODE YG963S6R

2. Application

PFC circuit(current continuous mode)

This diode is a product which optimizes the diode characteristic for the PFC circuit. This product is a product by which the trr characteristic was valued more than VF though there is a relation of the trade-off up to VF and Trr. The total loss of the PFC circuit can be suppressed by shortening trr.

3. OUT VIEW, MARKING, MOLDING RESIN, CHARACTERISTICS

(1) Out view is shown

MS5D1437 9/12

(2) Marking is shown

MS5D1437 9/12

It is marked to type name or abbreviated type name, polarity and Lot No.

(3) Molding resin

Epoxy resin

UL:V-0

(4) Characteristics is shown

MS5D1437 10/12~12/12

4. RATINGS

4.1 MAXIMUM RATINGS

| ITEM | SYMBOL | CONDITIONS | RATINGS | UNITS |
|-------------------------------------|-----------|--------------------------------|------------|-------|
| Repetitive peak reverse voltage | VRRM | | 600 | V |
| Non-repetitive peak reverse voltage | V_{RSM} | | 600 | V |
| Isolating voltage | Viso | Terminals-to-Case,AC.1min | 1500 | V |
| Surge peak forward current | lps | tw 200ns | 20 | Α |
| Peak forward current | lp | | 15 | Α |
| Average output current | lo | Square wave duty =1/2 Tc = 103 | 5 | А |
| Non-repetitive surge current | İFSM | Sine wave, 10ms | 40 | Α |
| Operating junction temperature | Tj | | 150 | °C |
| Storage temperature | Tstg | | -40~ + 150 | °C |

4.2 ELECTRICAL CHARACTERISTICS (at Ta=25 unless otherwise specified.)

| 112 222011 (16) (2 6) 13 (16) (2 1 (16) 1166 | | (dt 1d 20 dilloco otilorivico opcomodi) | | | |
|--|-----------------|---|---------|------|-------|
| ITEM | SYMBOL | CONDITIONS | MAXIMUM | | UNITS |
| Reverse recovery peak current | I _{RP} | =5A,-di/dt=200A/ μs,VR=380V Tj=100 Typ. 2.5 | | 2.5 | Α |
| Reverse recovery time | trr | F=0.1A,I _R =0.2,Irec=0.05A Max | | 30.0 | ns |
| Forward voltage | VF | IF= 15 A | Max. | 5.0 | V |
| Reverse current | lR | VR = VRRM | Max. | 50.0 | μΑ |
| Thermal resistance | Rth(j-c) | Junction to case | Max. | 3.5 | °C/W |

4.3 MECHANICAL CHARACTERISTICS

| Mounting torque | Recommended torque | 0.3 ~ 0.5 | N∙m |
|------------------|--------------------|-----------|-----|
| Approximate mass | | 2.0 | g |

9.

Fuii Electric Co..Ltd.

MS5D1437

7 3/12

This material and the information herein is the property of Fuji Electric Co. Ltd. They shall be neither reproduced, copied, lent, or disclosed in any way whatsoever for the use of any third party nor used for the manufacturing purposes without the express written consent of Fuji Electric Co. Ltd.

5.TEST

Test Test Testing methods and Conditions Reference Sampling Acceptance No. Items Standard number number EIAJ ED4701 1 Terminal Pull force Strength TO-220, TO-220F: 10N (Tensile) TO-3P,TO-3PF,TO-247: 25N A-111A TO-3PL: 45N method 1 T-Pack, K-Pack: 10N Force maintaining duration :30±1s 2 Terminal Load force Strength TO-220, TO-220F: 5N (Bending) TO-3P,TO-3PF,TO-247: 10N A-111A TO-3PL: 15N method 3 T-Pack, K-Pack: 5N Number of times :2times(90deg./time) (0:1)3 Mounting Screwing torque value: (M3) Mechanical test A-112 Strength TO-220, TO-220F: 40±10N TO-3P,TO-3PF,TO-247: 50±10N method 2 TO-3PL: 70±10N 4 Vibration frequency: 100Hz to 2kHz Acceleration: 100m/s² A-121 Sweeping time: 4min./1 cycle 4times for each X,Y&Z directions. 5 Shock Peak amplitude: 15km/s² A-122 Duration time: 0.5ms test code D 3times for each X,Y&Z directions. 6 Solderability Solder temp.: 235±5°C A-131A Immersion time: 5±0.5s Each terminal shall be immersed in test code A the solder bath within 1 to 3.0mm from the body. Solder temp.: 260±5°C Resistance to A-132 Soldering Heat Immersion time: 10±1s 5 Number of times: 1times

| This material and the information herein is the property of | Fuji Electric Co.,Ltd. They shall be neither reproduced, copied, | lent, or disclosed in any way whatsoever for the use of any | third party nor used for the manufacturing purposes without | the express written consent of Fuji Electric Co.,Ltd. |
|---|--|---|---|---|

Fuii Electric Co..Ltd.

9:

This material and the information herein is the property of Fuji Electric Co.,Ltd. They shall be neither reproduced, copied, lent, or disclosed in any way whatsever for the use of any third party nor used for the manufacturing purposes without the express written consent of Fuji Electric Co.,Ltd.

| 1 High Temp. Temperature :Tstg max B-111A 22 | | Test | Test | Testing methods and Conditions | Reference | | Acceptance |
|---|-------|------|---------------|---|-------------|--------|------------|
| 1 High Temp. Temperature :Tstg max B-111A 22 | | No. | Items | | Standard | number | number |
| Storage Test duration : 1000h 2 Low Temp. Temperature : Tstg min B-112A 22 Storage Test duration : 1000h 3 Temperature Temperature : 85±2°C B-121A test code C 22 Storage Test duration : 1000h 4 Temperature S5±2°C B-122A 22 Bias Bias Voltage : V _{RRM} × 0.8 test code C 22 Bias Bias Voltage : V _{RRM} × 0.8 test code C 22 Est duration : 1000h 5 Unsaturated Temperature : 120±2°C Pressurized Relative humidity : 85±5% B-122A 22 Vapor Vapor pressure : 170kPa test code B Test duration : 96h 6 Temperature High temp.side : Tstg max Cycle Room temp. : 5 ~ 35 Low temp.side : Tstg min Duration time : HT 30min,RT 5min LT 30min Number of cycles : 100 cycles Fluid : pure water(running water) High temp.side : 0+6/-0°C B-141A 22 Low temp.side : 0+6/-0°C B-141A 22 Est code A D-402 22 Est code A D-402 22 Est code A D-402 22 Est code A D-403 22 (0:1) Est duration : 1000h 9 Intermittent Tj=Tjmax ~ 50 D-403 22 (0:1) Est duration : 10000cy 10 High Temp. Temperature : Ta= 100 °C B-1404 22 Est code B Est code B | | | | | | | |
| 2 Low Temp. Temperature : Tstg min B-112A 22 | | 1 | High Temp. | Temperature :Tstg max | B-111A | 22 | |
| Storage Test duration : 1000h B-121A | | | Storage | Test duration: 1000h | | | |
| 1589 1580 | | 2 | Low Temp. | Temperature : Tstg min | B-112A | 22 | |
| Humidity Relative humidity : 85±5% test code C 22 | | | · · | Test duration : 1000h | | | |
| Storage | | 3 | Temperature | Temperature: 85±2°C | B-121A | | |
| 15 | | | Humidity | Relative humidity: 85±5% | test code C | 22 | |
| Humidity Bias Bias Voltage : V _{RRM} x 0.8 test code C | | | Storage | Test duration: 1000h | | | |
| Bias Bias Bias Voltage : V _{RRM} × 0.8 test code C | | 4 | Temperature | Temperature: 85±2°C | | | |
| Test duration : 1000h Temperature : 120±2°C Pressurized Relative humidity : 85±5% B-123A 22 Vapor Vapor pressure : 170kPa test code B Test duration : 96h Test duration : 97 Test duration : 98h Test duration : 175 Test duration : 175 Test duration : 175 Test duration : 185 T | | | Humidity | Relative humidity: 85±5% | B-122A | 22 | |
| 1 | ب اا | | Bias | Bias Voltage : V _{RRM} × 0.8 | test code C | | |
| 1 | les | | | Test duration: 1000h | | | |
| 1 | je j | 5 | Unsaturated | Temperature : 120±2°C | | | (0:1) |
| 1 | an (| | Pressurized | Relative humidity: 85±5% | B-123A | 22 | ` , |
| 1 | l iii | | Vapor | Vapor pressure : 170kPa | test code B | | |
| 1 | l c | | · | · · · | | | |
| Cycle | ШШ | 6 | Temperature | High temp.side : Tstg max | | | |
| Duration time: HT 30min,RT 5min LT 30min Number of cycles: 100 cycles 7 Thermal Shock Fluid: pure water(running water) High temp.side: 100+0/-5°C Low temp.side: 0+5/-0°C Duration time: HT 5min,LT 5min Number of cycles: 100 cycles 8 Steady state Ta=25±5°C Operating life Rated load D-402 22 Test duration: 1000h 9 Intermittent Tj=Tjmax ~ 50 Operating Jmin ON, 3min OFF Life Test duration: 10000cy 10 High Temp. Reverse Bias Ta=100 °C Reverse Bias Fluid: pure water(running water) B-141A 22 test code A D-402 22 Test code A D-402 22 Test code A D-402 22 Test duration: 1000h D-402 22 Test duration: 1000h D-403 22 Test duration: 10000cy D-403 22 Test duration: 10000cy D-404 22 | | | Cycle | | | | |
| Duration time: HT 30min,RT 5min LT 30min Number of cycles: 100 cycles 7 Thermal Shock Fluid: pure water(running water) High temp.side: 100+0/-5°C Low temp.side: 0+5/-0°C Duration time: HT 5min,LT 5min Number of cycles: 100 cycles 8 Steady state Ta=25±5°C Operating life Rated load D-402 22 Test duration: 1000h 9 Intermittent Tj=Tjmax ~ 50 Operating Jmin ON, 3min OFF Life Test duration: 10000cy 10 High Temp. Reverse Bias Ta=100 °C Reverse Bias Fluid: pure water(running water) B-141A 22 test code A D-402 22 Test code A D-402 22 Test code A D-402 22 Test duration: 1000h D-402 22 Test duration: 1000h D-403 22 Test duration: 10000cy D-403 22 Test duration: 10000cy D-404 22 | | | | Low temp.side : Tstg min | B-131A | 22 | |
| Thermal Shock | | | | • · · · · · · · · · · · · · · · · · · · | | | |
| Thermal Shock | | | | | | | |
| High temp.side : 100+0/-5°C | | 7 | Thermal Shock | | | | |
| Low temp.side: 0+5/-0°C test code A Duration time: HT 5min,LT 5min Number of cycles: 100 cycles 8 Steady state Ta=25±5°C Operating life Rated load Test duration: 1000h 9 Intermittent Tj=Tjmax ~50 Operating 3min ON, 3min OFF Life Test duration: 10000cy 10 High Temp. Temperature: Ta= 100 °C Reverse Bias Bias Voltage: V _R =V _{RRM} duty=1/2 D-404 22 test code A test code A D-402 22 (0:1) | | | | | B-141A | 22 | |
| Duration time : HT 5min,LT 5min Number of cycles : 100 cycles | | | | | test code A | | |
| Number of cycles : 100 cycles | | | | | | | |
| 8 Steady state | | | | Number of cycles : 100 cycles | | | |
| Operating life | | 8 | Steady state | | | | |
| Test duration : 1000h | | | - | Rated load | D-402 | 22 | |
| 9 Intermittent Tj=Tjmax ~50 Operating 3min ON, 3min OFF Life Test duration : 10000cy 10 High Temp. Temperature : Ta= 100 °C Reverse Bias Bias Voltage : V _R =V _{RRM} duty=1/2 D-404 22 | | | , , | Test duration : 1000h | | | |
| Operating Life 3min ON, 3min OFF Test duration : 10000cy D-403 22 (0:1) 10 High Temp. Reverse Bias Temperature : Ta= 100 °C Bias Voltage : V _R =V _{RRM} duty=1/2 D-404 22 | | 9 | Intermittent | | | | |
| Life Test duration : 10000cy 10 High Temp. Temperature : Ta= 100 °C Reverse Bias Bias Voltage : V _R =V _{RRM} duty=1/2 D-404 22 | | | Operating | 1 | D-403 | 22 | (0:1) |
| 10 High Temp. Temperature: Ta= 100 °C Reverse Bias Bias Voltage: V _R =V _{RRM} duty=1/2 D-404 22 | | | | | | | ` ' |
| Reverse Bias Bias Voltage : V _R =V _{RRM} duty=1/2 D-404 22 | | 10 | | | | | |
| | | | | | D-404 | 22 | |
| TI GU GUIGUOTI, TOOOTI | | | | Test duration : 1000h | | | |

| Failure Criteria | I_R | USL x 5 |
|------------------|-------|-----------|
| | V_F | USL x 1.1 |

USL:Upper specification Limit

6.Cautions

- · Although Fuji Electric is continually improving product quality and reliability, a small percentage of semiconductor products may become faulty. When using Fuji Electric semiconductor products in your are requested to take adequate safety measures to prevent the equipment from causing physical injury, fire,or other problem in case any of the products fail. It is recommended to make your design fail-safe, flame retardant, and free of malfunction.
- The products described in this Specification are intended for use in the following electronic and electrical equipment which has normal reliability requirements.
- ·Computers ·OA equipment ·Communications equipment(Terminal devices)
- · Measurement equipment
- · Machine tools
- · AV equipment
- · Electrical home appliances · Personal equipment
- · Industrial robots

- ·The products described in this Specification are not designed or manufactured tobe used in equipment or systems used under life-threatening situations. If you are considering using these products in the equipment listed below, first check the system construction and required reliability.
- ·Transportation equipment(automobiles, trains, ships, etc.)
- ·Backbone network equipment

- ·Traffic-signal control equipment
- · Gas alarms, leakage gas auto breakers
- · Submarine repeater equipment
- · Burglar alarms, fire alarms, emergency equipment
- · Medical equipment

· Nuclear control equipment

Do not use the products in this Specification for equipment requiring strict reliability such as(but not limited to):

· Aerospace equipment · Aeronautical equipment

7.Warnings

- ·The Diodes should be used in products within their absolute maximaum rating(vltage, current, temperature,etc.). The Diodes may be destroyed if used beyond the rating.
- •The equipment containing Diodes should have adequate fuses or protection to prevent the equipment from causing secondary destruction.
- ·Use the Diodes within their reliability and lifetime under certain environments or conditions. The Diodes may fail before the target lifetime of your products if used under certain reliability conditions.
- You must design the Diodes to be operated within the specified maximum ratings(voltage, current,temperature,etc.)toprevent possible failure or destruction of devices.
- ·Consider the possible temperature rise not only for the junction and case, but also for the
- · Do not directly touch the leads or package of the Diodes while power is supplied or during operation, to avoid electric shock and burns.

- The Diodes are made of incombustible material. However, if a Diode fails, it may emit smoke of flame. Also, operating the Diodes near any flammable place or material may cause the Diodes to emit smoke or flame in case the Diodes become even hotter during operation. Design the arrangement to prevent the spread of fire.
- The Diodes should not used in an environment in the presence of acid,organic matter,or corrosive gas(hydrogen sulfide,sulfurous acid gas.)
- The Diodes should not used in an irradiated field since they are not radiation-proof.

Insatallation

- · Soldering involves temperatures which exceed the device storage temperature rating. To avoid device damage and to ensure reliability, observe the following guidelines from the quality assurance standard.
- · Solder temperature and duration(through-hole package)

| Solder | Duration |
|-------------|----------------------|
| temperature | |
| 260 ± 5 | 10 ± 1second |
| 350 ± 10 | 3.0 ± 0.5 second |

- •The immersion depth of the lead should basically be up to the lead stopper and the distance should be a maximum of 1.5mm from the device.
- ·When flow-soldering, take care to avoid immersing the package in the solder bath.
- •Refer to the following torque reference When mounting the device on a heat sink. Excess torque applied to the mounting screw causes damage to the device and weak torque will increase the thermal resistance, both of which conditions may destory the device.

Table 1:Recommended tightening torque

| Package style | Screw | Recommended tightening |
|---------------|-------|------------------------|
| | | torque |
| TO-220 | M3 | 30-50Ncm |
| TO-220F | | |
| TO-3P | M3 | 40-60Ncm |
| TO-3PF | | |
| TO-247 | | |
| TO-3PL | M3 | 60-80Ncm |

- •The heat sink should have a flatness within \pm 50 μ m and roughness within 10 μ m. Also,keep the tightening torque within the limits of this specification.
- Improper handling may cause isolation breakdown leading to a critical accident.
- ·We recommend the use of thermal compound to optimize the efficiency of heat radiation.It is important to evenly apply the compound and to eliminate any air viods.

Storage

- •The Diodes must be stored at a standard temperature of 5 to 35 and relative humidity of 45 to 75%. If the storage area is very dry, a humidifier may be required. In such a case, use only deionized water or boiled water, since the chlorine in tap water may corrode the leads.
- The Diodes should not be subjected to rapid changes in temperature to avoid condensation on the suface of the Diodes. Therfore, store the Diodes in a place Where the temperature is steady.
- •The Diodes should not be stored on top of each other, since this may cause excessive external force on the case.
- •The Diodes should not be stored with the lead terminals remaining unprocessed.Rust may cause presoldered connections to go fail during later processing.
- The Diodes should be stored in antistatic containers or shipping bags.

8.Appendix

- ·These products do not contain PBDOs or PBBs.
- •These products, assemblies, or components do not contain any of the above-mentioned substances.

Prohibited substances:

CFCs,halon,carbon tetrachloride,1,1,1-trichloroethane(metyl chloroform)

These products, assemblies, or components are not manufactured using any of the above-mentioned substances.

Prohibited substances:

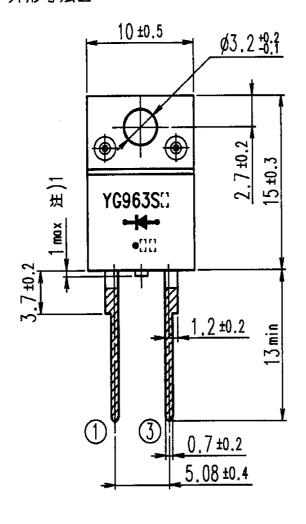
CFCs,halon,carbon tetrachloride,1,1,1-trichloroethane(methyl chloroform)

- ·If you have any questions about any part of this Specification, please contact Fuji Electric or its sales agentbefore using the product
- Neither Fuji nor its agents shall be held liable for any injury caused by using the products not in accordance with the instructions.
- •The application examples described in this specification are merely typical uses of Fuji Electric products.

This specification does not confer any industrial property rights or other rights, nor constitute a license for such rights.

FUJI SILICON DIODE

OUT VIEW 外形寸法図 TYPE: YG963SER

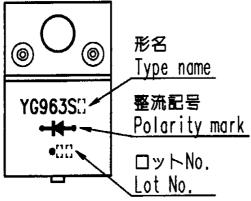


4.5 ±0.2 2.7 ±0.2 予備はんだ PRE-SOLDER $0.6^{+0.2}$ 2.7 ±0.2

MARKING 表示内容

This material and the information herein is the property of Fuji Electric Co.,Ltd. They shall be neither reproduced, copied, lent, or disclosed in any way whatsoever for the use of any third, and they nor used for the manufacturing purposes without the express written consent of Fuji Electric Co.,Ltd.





CONNECTION 結線図



注)1.端子間 (3端子品におけるセンター 端子部=破線部) の樹脂残りは、 1.0mm 以下とする。

> UNIT:mm 寸法単位:mm

Fuii Electric Co..Ltd.

9.

MS5D1437 9/12

Reverse Characteristic (typ.) Forward Characteristic (typ.) 100 Tj=150°C 10¹ Ti=125°C Tj=100°C 10 10° Reverse Current (µA) 10⁻¹ Forward Current (A) Tj=150°C Tj=125°C Tj=100°C <u>∝</u> 10⁻² Tj=25°C Tj=25°C Щ 0.1 10-3 10⁻⁴ 0.01 0 100 200 300 400 500 600 700 0.5 3.5 4.5 0.0 1.0 1.5 2.0 2.5 3.0 4.0 VR Reverse Voltage (V) VF Forward Voltage (V) Forward Power Dissipation Reverse Power Dissipation 25 0.045 DC 0.040 20 0.035 $\stackrel{\textstyle <}{\leq}$ 350 € 0.030 Forward Power Dissipation Dissipation 0.025 15 Power 0.020 α=180° Reverse 7 0.015 10 ¥ PR 0.010 5 0.005 0.000 0 5 6 100 200 300 400 500 700 0 VR Reverse Voltage (V) lo Average Forward Current (A)

This material and the information herein is the property of Fuji Electric Co.,Ltd. They shall be neither reproduced, copied, lent, or disclosed in any way whatsoever for the use of any third parry nor used for the manufacturing purposes without the express written consent of Fuji Electric Co.,Ltd.

9.

This material and the information herein is the property of Fuji Electric Co. Ltd. They shall be neither reproduced, copied, lent, or disclosed in any way whatsoever for the use of any third party nor used for the manufacturing purposes without the express written consent of Fuji Electric Co. Ltd.

